



MOSFET

OptiMOS[™] 5 Power-Transistor, 25 V

Features

- Optimized for OR-ing application
 Very low on-resistance R_{DS(on)} @ V_{GS}=4.5 V
 100% avalanche tested
 Superior thermal resistance

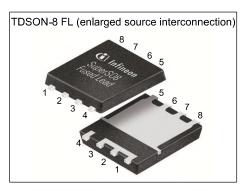
- N-channel
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

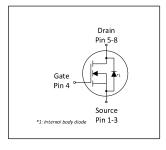
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
V _{DS}	25	V
R _{DS(on),max}	0.45	mΩ
ID	479	A
Q _{oss}	70	nC
Q _G (0V4.5V)	135	nC









Type / Ordering Code	Package	Marking	Related Links
BSC004NE2LS5	PG-TDSON-8 FL	04NE2LS5	-



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1 Maximum ratings at *T*_A=25 °C, unless otherwise specified

Table 2Maximum ratings

Demonsterne (dem	0		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D			479 338 40	A	V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =4.5V, T_{A} =25°C, R_{thJA} =50°C/W ²)	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1914	А	<i>T</i> _A =25 °C	
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	400	mJ	I _D =20 A, R _{GS} =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	188 2.5	w	$T_{\rm C}=25 \ ^{\circ}{\rm C}$ $T_{\rm A}=25 \ ^{\circ}{\rm C}, \ R_{\rm thJA}=50 \ ^{\circ}{\rm C/W}^{2)}$	
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56	

2 **Thermal characteristics**

Table 3 **Thermal characteristics**

Parameter	Symbol	Values			Unit	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	$R_{ m thJC}$	-	-	0.8	°C/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	-	20	°C/W	-
Device on PCB, 6 cm² cooling area	R _{thJA}	-	-	50	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. ²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain

connection. PCB is vertical in still air.

 ³⁾ See Diagram 3 for more detailed information
 ⁴⁾ See Diagram 13 for more detailed information



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Devenuetor	Symphical		Values			Note / Toot Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	25	-	-	V	V _{GS} =0 V, <i>I</i> _D =1 mA	
Gate threshold voltage	V _{GS(th)}	1.0	1.5	2.0	V	V _{DS} =V _{GS} , <i>I</i> _D =250 μA	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1.0 100	μA	V _{DS} =20 V, V _{GS} =0 V, T _j =25 °C V _{DS} =20 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =16 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	0.40 0.54	0.45 0.85	mΩ	V _{GS} =10 V, <i>I</i> _D =30 A V _{GS} =4.5 V, <i>I</i> _D =30 A	
Gate resistance	R _G	-	0.7	-	Ω	-	
Transconductance	$g_{ m fs}$	-	230	-	S	<i>V</i> _{DS} ≥2 <i>I</i> _D <i>R</i> _{DS(on)max} , <i>I</i> _D =30 A	

Table 5Dynamic characteristics

Devenueten	Course had	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	11000	-	pF	V _{GS} =0 V, V _{DS} =12.5 V, <i>f</i> =1 MHz
Output capacitance	Coss	-	3600	-	pF	V _{GS} =0 V, V _{DS} =12.5 V, <i>f</i> =1 MHz
Reverse transfer capacitance	Crss	-	3100	-	pF	V _{GS} =0 V, V _{DS} =12.5 V, <i>f</i> =1 MHz
Turn-on delay time	t _{d(on)}	-	28	-	ns	$V_{\rm DD}$ =12.5 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	tr	-	88	-	ns	$V_{\rm DD}$ =12.5 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	t _{d(off)}	-	68	-	ns	$V_{\rm DD}$ =12.5 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	93	-	ns	V _{DD} =12.5 V, V _{GS} =4.5 V, <i>I</i> _D =30 A, <i>R</i> _{G,ext} =1.6 Ω

Gate charge characteristics¹⁾ Table 6

	Ok. a l		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q _{gs}	-	24	-	nC	V_{DD} =12.5 V, I_{D} =30 A, V_{GS} =0 to 4.5 V	
Gate charge at threshold	Q _{g(th)}	-	15	-	nC	V _{DD} =12.5 V, <i>I</i> _D =30 A, <i>V</i> _{GS} =0 to 4.5 V	
Gate to drain charge	Q _{gd}	-	69	-	nC	V_{DD} =12.5 V, I_{D} =30 A, V_{GS} =0 to 4.5 V	
Switching charge	Q _{sw}	-	78	-	nC	V_{DD} =12.5 V, I_{D} =30 A, V_{GS} =0 to 4.5 V	
Gate charge total	Qg	-	135	-	nC	V_{DD} =12.5 V, I_{D} =30 A, V_{GS} =0 to 4.5 V	
Gate plateau voltage	V _{plateau}	-	2.2	-	V	V_{DD} =12.5 V, I_{D} =30 A, V_{GS} =0 to 4.5 V	
Gate charge total	Qg	-	238	-	nC	V_{DD} =12.5 V, I_{D} =30 A, V_{GS} =0 to 10 V	
Output charge	Qoss	-	70	-	nC	V _{DS} =12.5 V, V _{GS} =0 V	

¹⁾ See "Gate charge waveforms" for parameter definition

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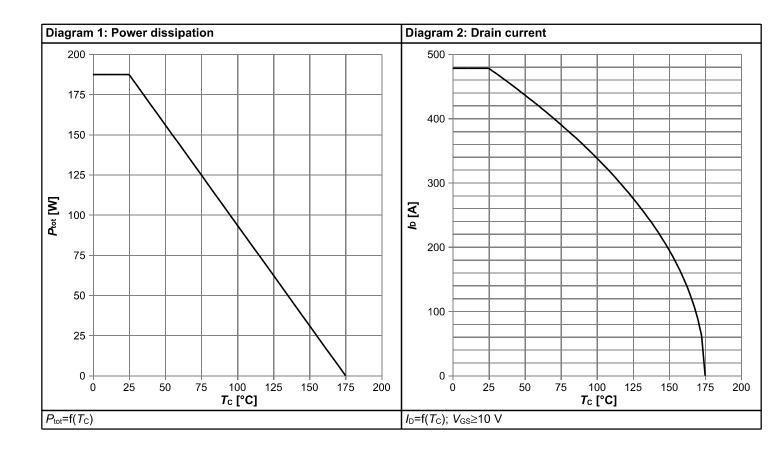


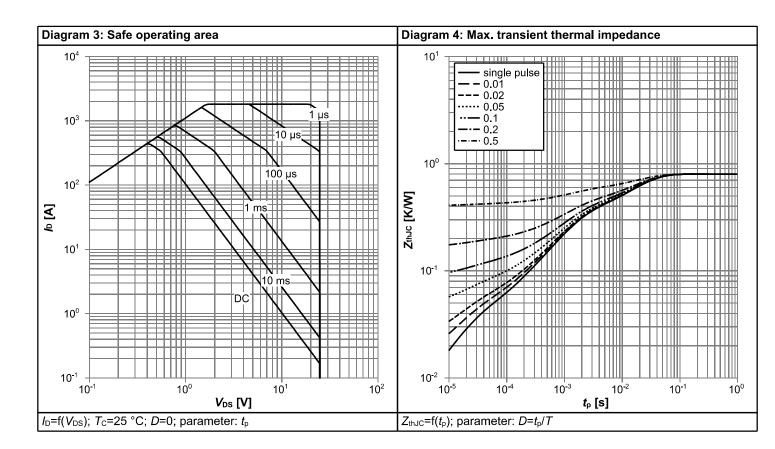
Table 7Reverse diode

Peremeter	Symbol	Values			Unit	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.		Note / Test Condition	
Diode continuous forward current	ls	-	-	188	А	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	1914	А	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.77	1.0	V	V _{GS} =0 V, <i>I</i> _F =30 A, <i>T</i> _j =25 °C	
Reverse recovery charge	Qrr	-	30	-	nC	V _R =12.5 V, <i>I</i> _F = <i>I</i> _S , d <i>i</i> _F /d <i>t</i> =400 A/µs	

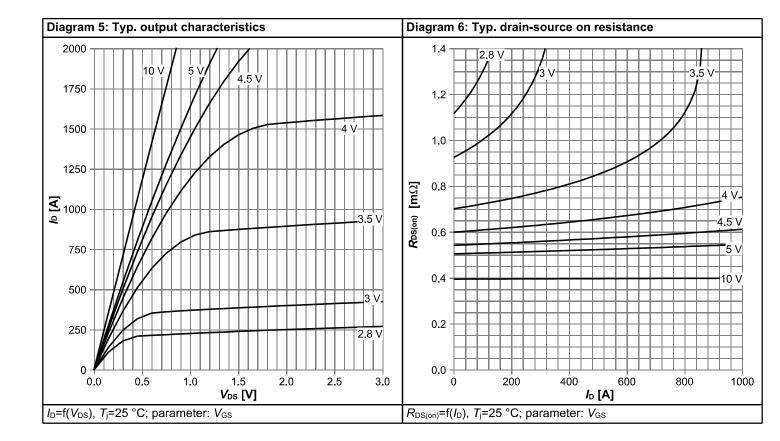


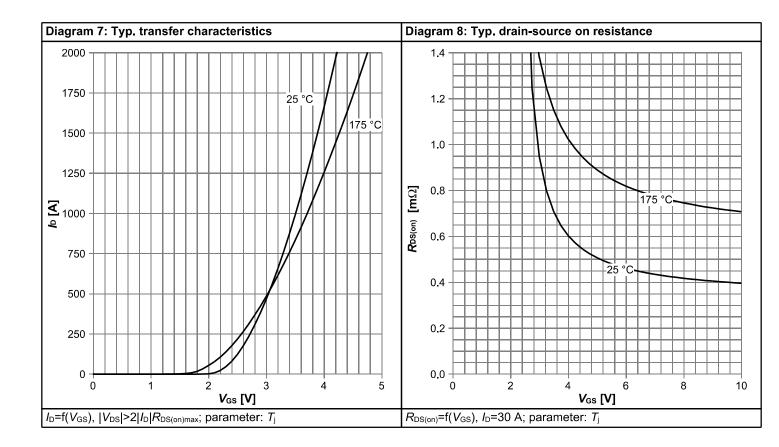
4 Electrical characteristics diagrams



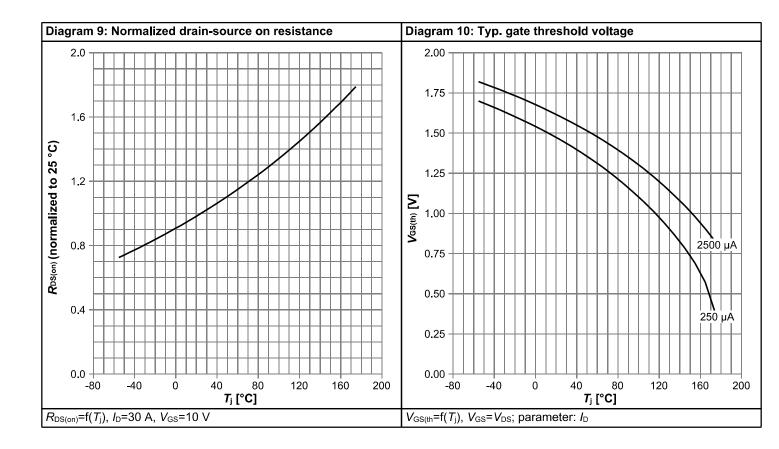


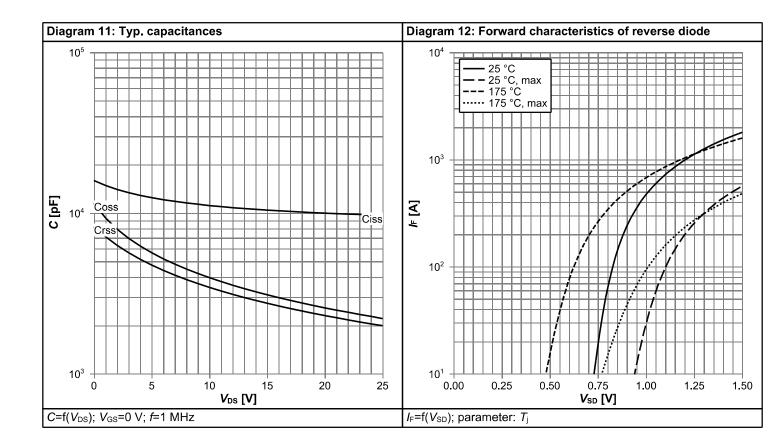




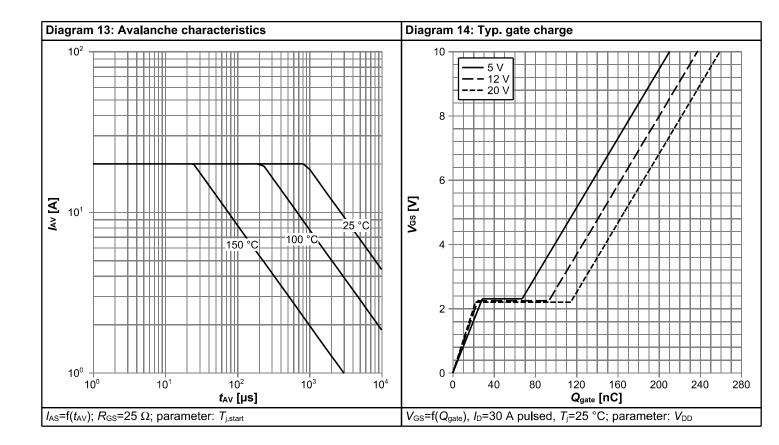


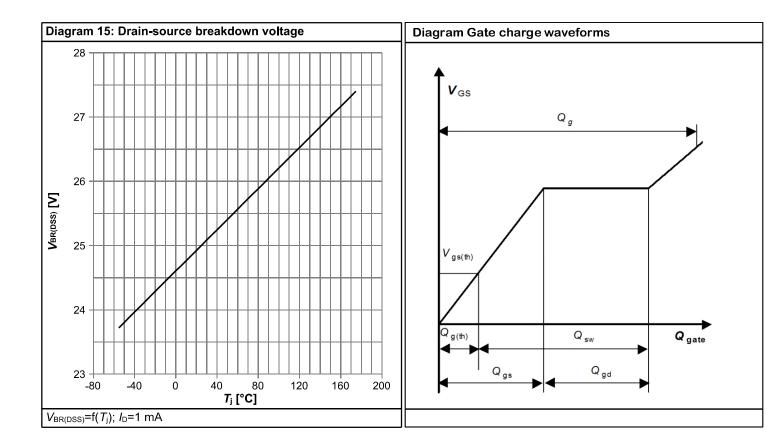








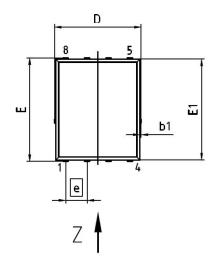


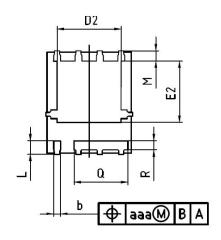


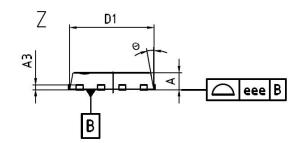




5 Package Outlines







DIM	MILLIN	IETERS	INC	HES	DOCUMENT NO.
DIM	MIN	MAX	MIN	MAX	Z8B00162237
А	0.90	1.10	0.035	0.043	
A3	0.25	(REF)	0.011	(REF)	SCALE 03
b	0.34	0.54	0.013	0.021	
b1	0.02	0.22	0.001	0.009	2.5
D	5.15	(BSC)	0.203	(BSC)	3
D1	5.00	(BSC)	0.197	(BSC)	0 2.5
D2	3.70	4.40	0.146	0.173	5mm
E	6.15	(BSC)	0.242 (BSC)		c
E1	6.00	(BSC)	0.236	(BSC)	EUROPEAN PROJECTION
E2	3.40	3.80	0.134	0.150	EUROPEAN PROJECTION
е	1.27	(BSC)	0.050	(BSC)	
N		8		8	
L	0.74	0.84	0.029	0.033	$\square \circledast$
М	0.45	0.66	0.018	0.026	
Θ	8.5°	12°	8.5°	12°	ISSUE DATE
Q	3.15	3.25	0.124	0.128	02-08-2011
R	0.48	0.58	0.019	0.023	
aaa	0.	25	0.0	010	REVISION
eee	0.	08	0.0	003	01

Figure 1 Outline PG-TDSON-8 FL, dimensions in mm/inches



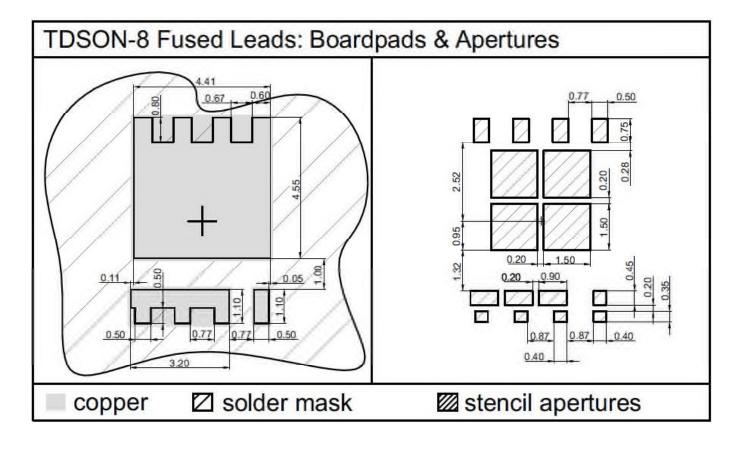


Figure 2 Outline Boardpads (TDSON-8 FL)



Revision History

BSC004NE2LS5

Revision: 2021-03-08, Rev. 2.1

Previous Revision						
Revision	Date	Subjects (major changes since last revision)				
2.0	2020-04-23	Release of final version				
2.1	2021-03-08	Update Id condition for EAS and VGS(th)				

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